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# **FDP027N08B** N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 223 A, 2.7 mΩ

## **Features**

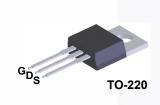
- $R_{DS(on)}$  = 2.21 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V, I<sub>D</sub> = 100 A
- Low FOM R<sub>DS(on)</sub> \* Q<sub>G</sub>
- Low Reverse-Recovery Charge, Q<sub>rr</sub> = 112 nC
- Soft Reverse-Recovery Body Diode
- Enables High Efficiency in Synchronous Rectification
- · Fast Switching Speed
- · 100% UIL Tested
- · RoHS Compliant

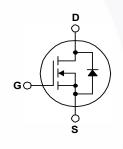
# Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

# Applications

- · Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- · Motor Drives and Uninterruptible Power Supplies





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

| Symbol                            | Parameter  |   | FDP027N08B_F102 | Unit           |  |
|-----------------------------------|--|---|-----------------|----------------|--|
| V <sub>DSS</sub>                  | Drain to Source Voltage  |   | 80              | V              |  |
| V <sub>GSS</sub>                  | Gate to Source Voltage   |   | ±20             | V              |  |
| I <sub>D</sub> Drair              |  | - Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Silicon Limited)  | 223*            | 223*<br>158* A |  |
|                                   | Drain Current  | - Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, Silicon Limited) | 158*            |                |  |
|                                   |  | - Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Package Limited)  | 120             |                |  |
| I <sub>DM</sub>                   | Drain Current  | - Pulsed (Note 1)   | 892             | Α              |  |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy (Note 2)                              |   | 917             | mJ             |  |
| dv/dt                             | Peak Diode Recovery dv/dt (Note 3)                                   |   | 6.0             | V/ns           |  |
| P <sub>D</sub> Po                 | Power Dissinction  | (T <sub>C</sub> = 25°C)   | 246             | W              |  |
|                                   | Power Dissipation  | - Derate Above 25°C   | 1.64            | W/ºC           |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                              |   | -55 to +175     | °C             |  |
| TL                                | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds |   | 300             | °C             |  |

\*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120 A.

# **Thermal Characteristics**

| Symbol                | Parameter FDP027N08B_F                          |      | Unit |  |
|-----------------------|---|------|------|--|
| $R_{	extsf{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. 0.61 |      |      |  |
| $R_{	extsf{	heta}JA}$ | Thermal Resistance, Junction to Ambient, Max.   | 62.5 | °C/W |  |

November 2013

|                       |   | Package                 | •           |  | Тар                         | e Width | Qua         | ntity      |         |
|-----------------------|---|-------------------------|-------------|--|-----------------------------|---------|-------------|------------|---------|
|                       |   | TO-220                  |             |  |                             | N/A     | 50 units    |            |         |
| Electrica             | I Chara   | acteristics $T_c$ =     | 25°C unless | otherwise noted.   |                             |         |             |            |         |
| Symbol                |   | Parameter               |             | Test Conditions  |                             | Min.    | Тур.        | Max.       | Unit    |
| Off Charac            | teristics                                       | 1                       |             |  |                             |         |             |            |         |
| BV <sub>DSS</sub>     | 1   | ,<br>Source Breakdown V | oltage      | I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V   |                             | 80      | _           | _          | V       |
| ΔBV <sub>DSS</sub>    |   | wn Voltage Temperat     | 0           | $I_D = 250 \ \mu\text{A}, \ \text{Referenced to } 25^{\circ}\text{C}$  |                             | 00      |             |            |         |
| $/\Delta T_J$         | Coefficie                                       | <b>U</b> 1              |             |  |                             | -       | 0.05        | -          | V/°C    |
|                       |   |                         |             | V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V  |                             | -       | -           | 1          |         |
| DSS                   | Zero Gat  | te Voltage Drain Curro  | ent         | $V_{\rm DS} = 64 \text{ V}, T_{\rm C} = 150^{\circ}\text{C}$   |                             | -       | -           | 500        | μA      |
| I <sub>GSS</sub>      | Gate to E                                       | Body Leakage Currer     | nt          | $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$  |                             | -       | -           | ±100       | nA      |
| On Charac             | toriotico                                       |                         |             |  |                             |         |             | 1          |         |
|                       |   |                         | _           | V = V   = 250 ···  | ^                           | 25      |             | 4.5        | V       |
| V <sub>GS(th)</sub>   |   | eshold Voltage          | iotonoo     | $V_{GS} = V_{DS}, I_{D} = 250 \mu$   |                             | 2.5     | -           | 4.5<br>2.7 |         |
| R <sub>DS(on)</sub>   |   |                         | sistance    | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$<br>$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$ |                             | -       | 2.21<br>227 |            | mΩ<br>S |
| 9 <sub>FS</sub>       |   | Transconductance        |             | $v_{\rm DS} = 10 v, i_{\rm D} = 100 v$   |                             | -       | 221         | -          | 3       |
| Dynamic C             | haracte   | ristics                 |             |  |                             |         |             |            | -       |
| C <sub>iss</sub>      | Input Ca  | t Capacitance           |             | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V,   |                             | -       | 10170       | 13530      | pF      |
| C <sub>oss</sub>      | Output C  | apacitance              |             | f = 1  MHz   |                             | -       | 1670        | 2220       | pF      |
| C <sub>rss</sub>      | Reverse   | Transfer Capacitance    | e           |  |                             | -       | 35          | -          | pF      |
| C <sub>oss</sub> (er) | Engry Related Output Capacitance                |                         | ance        | $V_{DS}$ = 40 V, $V_{GS}$ = 0 V  |                             | -       | 3025        | -          | pF      |
| Q <sub>g(tot)</sub>   | Total Gat                                       | e Charge at 10V         |             |  |                             | -       | 137         | 178        | nC      |
| Q <sub>gs</sub>       | Gate to S                                       | Source Gate Charge      |             | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V,<br>I <sub>D</sub> = 100A<br>f = 1 MHz                            |                             | -       | 56          | -          | nC      |
| Q <sub>gs2</sub>      | Gate Cha  | arge Threshold to Pla   | iteau       |  |                             | -       | 25          | -          | nC      |
| Q <sub>gd</sub>       | Gate to E                                       | Drain "Miller" Charge   |             |  |                             | -       | 28          | -          | nC      |
| ESR                   | Equivale  | nt Series Resistance    | (G-S)       |  |                             | -       | 2.4         | -          | Ω       |
| Switching             | Charact   | eristics                |             |  |                             |         |             |            |         |
| t <sub>d(on)</sub>    |   | Delay Time              |             |  |                             |         | 47          | 104        | ns      |
| t <sub>r</sub>        | Turn-On   | Rise Time               |             | $V_{DD}$ = 40 V, I <sub>D</sub> = 100 A,<br>$V_{GS}$ = 10 V, R <sub>G</sub> = 4.7 Ω<br>(Note 4)                  |                             |         | 66          | 142        | ns      |
| t <sub>d(off)</sub>   | Turn-Off  | Delay Time              |             |  |                             | -       | 87          | 184        | ns      |
| t <sub>f</sub>        | Turn-Off  | Fall Time               |             |  |                             | 7-      | 41          | 92         | ns      |
| Drain Sour            |   | e Characteristic        | e           |  |                             |         |             |            |         |
|                       |   |                         |             | e Forward Current  |                             | -       | -           | 223*       | А       |
| I <sub>S</sub><br>I   | Maximum Continuous Drain to Source Dio          |                         |             |  |                             |         |             | 892        |         |
| I <sub>SM</sub>       | Maximum Pulsed Drain to Source Diode Fo         |                         |             |  |                             | -       | -           |            | A<br>V  |
| V <sub>SD</sub>       |   |                         | u voltage   | $V_{GS} = 0 V, I_{SD} = 100 A$   |                             | -       | - 80        | 1.3        |         |
| t <sub>rr</sub>       |   | Recovery Time           |             | $V_{GS} = 0 V, V_{DD} = 40 V$  | /, I <sub>SD</sub> = 100 A, | -       | 80          | -          | ns      |
| Q <sub>rr</sub>       | Reverse Recovery Charge $dI_F/dt = 100 A/\mu s$ |                         |             | -  | 112                         | -       | nC          |            |         |

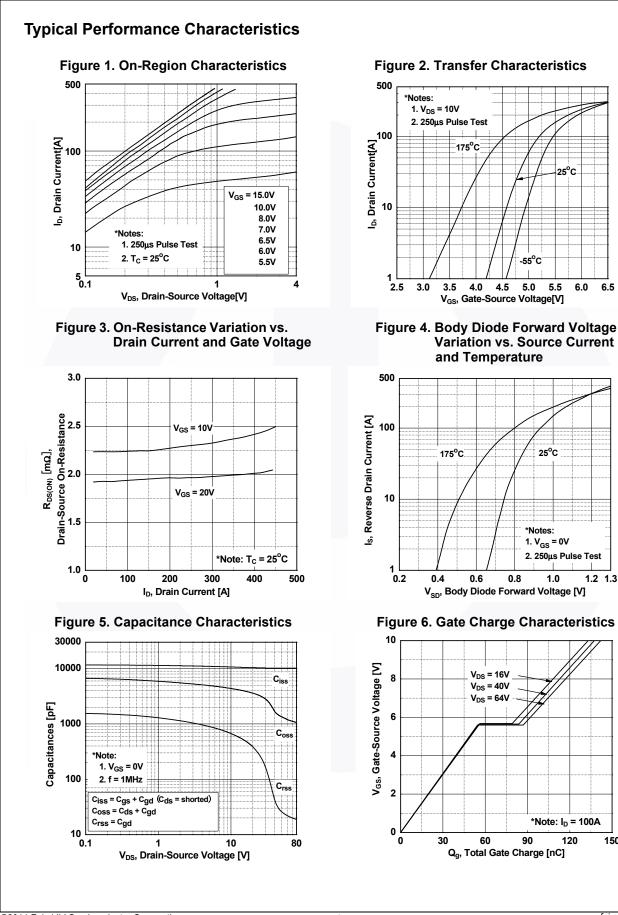
 $\begin{array}{l} \text{2. L}=3\text{ mH},\ \text{I}_{AS}=24.72\text{ A},\ \text{R}_{G}=25\ \Omega,\ \text{starting }\ \text{T}_{J}=25^{\circ}\text{C}.\\ \text{3. I}_{SD}\leq100\text{ A},\ \text{di/dt}\leq200\text{ A/}\mu\text{s},\ \text{V}_{DD}\leq\text{BV}_{DSS},\ \text{starting }\ \text{T}_{J}=25^{\circ}\text{C}. \end{array}$ 

Essentially independent of operating temperature typical characteristics.

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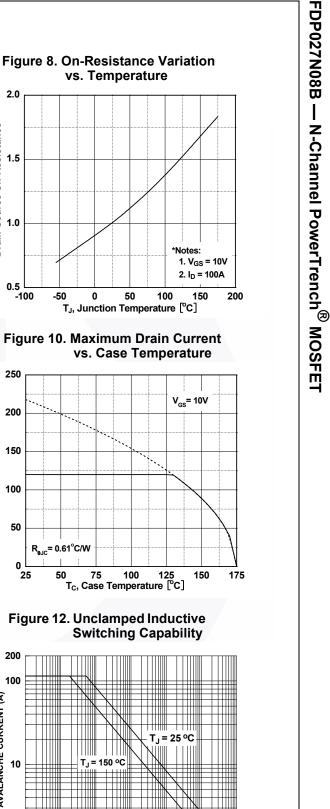
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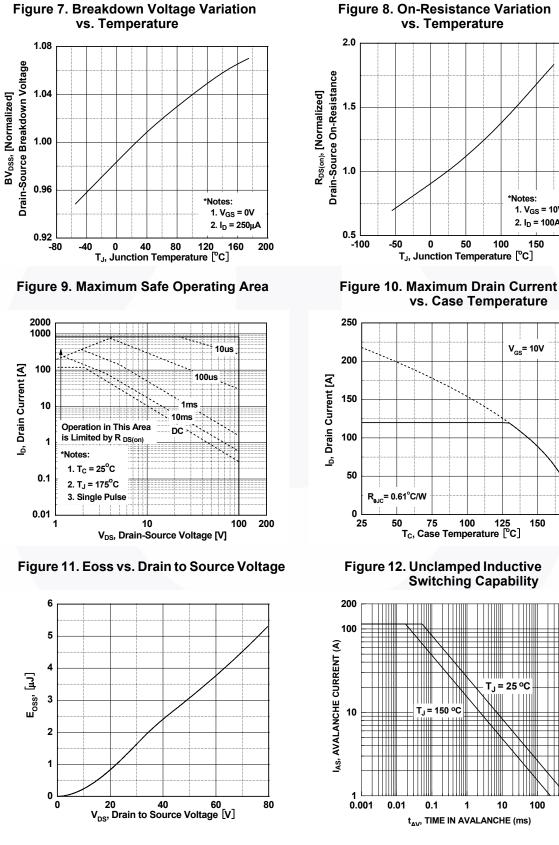


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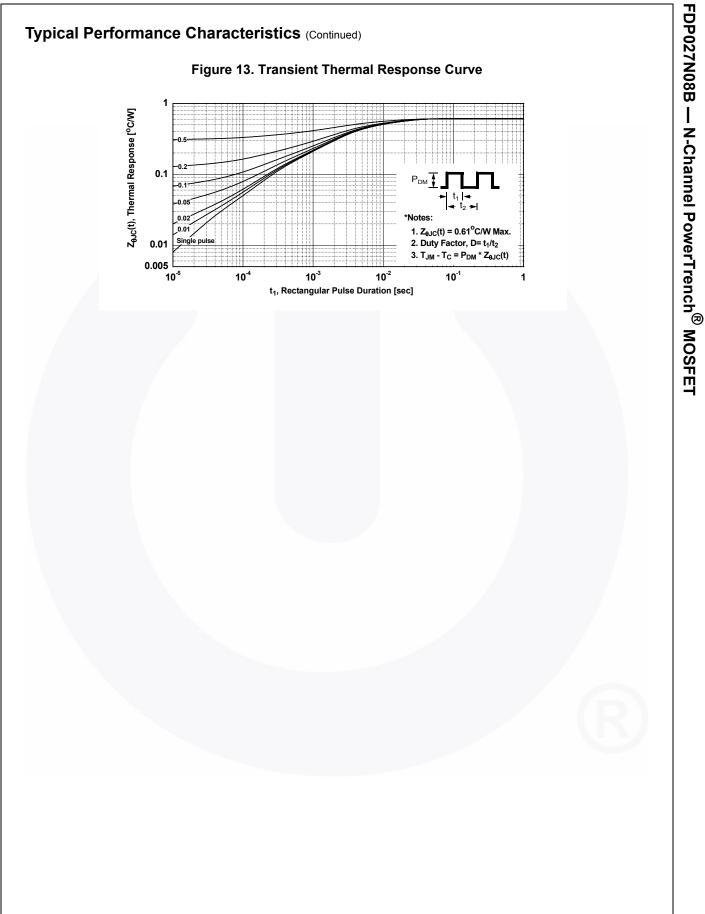
### Typical Performance Characteristics (Continued)

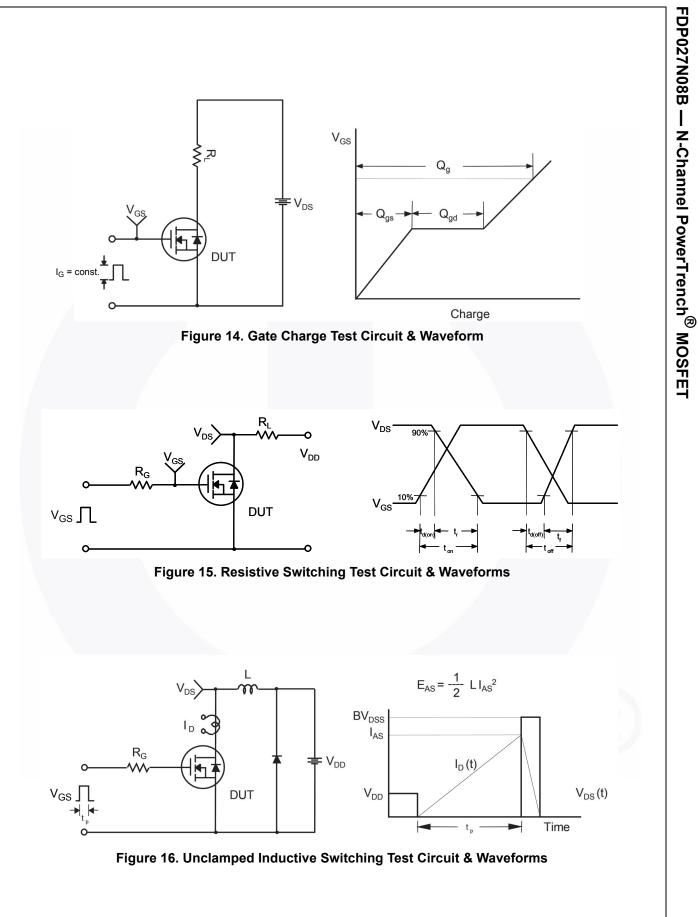
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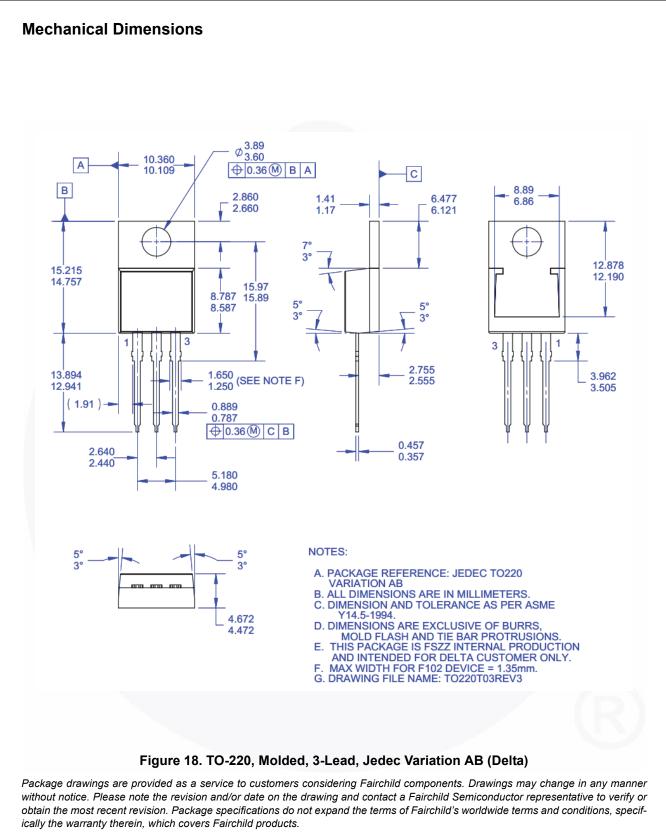
100





DUT +  $v_{DS}$ a ۱<sub>SD</sub> م L Driver R<sub>G</sub>, Same Type as DUT L F ∨<sub>DD</sub>  $\prod V_{GS}$ • dv/dt controlled by R<sub>G</sub> • I<sub>SD</sub> controlled by pulse period Î Gate Pulse Width V<sub>GS</sub> D = Gate Pulse Period 10V (Driver) I<sub>FM</sub>, Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current  $V_{DS}$ (DUT) Body Diode Recovery dv/dt  $V_{SD}$ V<sub>PD</sub> Body Diode Forward Voltage Drop Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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